

N-Ch MOSFET

General Description

The WSD80120DN56 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications . The WSD80120DN56 meet the RoHS and Green Product requirement,100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summery

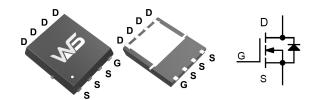
BV _{DSS}	R _{DSON}	I _D
85V	$3.7 m\Omega$	120A

Applications

High power DC/DC converters and switch mode power supply

DC Motor control and Class D Amplifier

DFN5X6-8 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	85	V
V_{GS}	Gate-Source Voltage	±25	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V	120	Α
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V	96	Α
I _{DM}	Pulsed Drain Current T _C =25°C	384	Α
EAS	Avalanche Energy, Single pulse,L=0.5mH	320	mJ
I _{AS}	Avalanche Current, Single pulse,L=0.5mH	180	Α
P _D @T _C =25℃	Total Power Dissipation	104	W
P _D @T _C =100℃	Total Power Dissipation	53	W
T _{STG}	Storage Temperature Range	-55 to 175	°C
TJ	Operating Junction Temperature Range	175	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient		20	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case		1.2	°C/W



Electrical Characteristics (T_J=25 C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	85			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA		0.096		V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V,I _D =50A		3.7	4.8	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} . In =250uA	2.0	3.0	4.0	٧
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID -250UA		-5.5		mV/℃
	Drain-Source Leakage Current	V_{DS} =85V , V_{GS} =0V , T_{J} =25 $^{\circ}$ C			1	uA
I _{DSS}		V_{DS} =85V , V_{GS} =0V , T_{J} =55 $^{\circ}$ C			10	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±25V , V _{DS} =0V			±100	nA
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		3.2		Ω
Q_{g}	Total Gate Charge (10V)			54		nC
Q _{gs}	Gate-Source Charge	V _{DS} =50V , V _{GS} =10V , I _D =10A		17		
Q_gd	Gate-Drain Charge			11		
T _{d(on)}	Turn-On Delay Time			21		
Tr	Rise Time	V _{DD} =50V , V _{GS} =10V ,		1 .0		
T _{d(off)}	Turn-Off Delay Time	R_G =1 Ω ,RL=1 Ω ,IDS=10A.		36		ns
T _f	Fall Time			10		1
C _{iss}	Input Capacitance	V _{DS} =40V , V _{GS} =0V , f=1MHz		3750		
C _{oss}	Output Capacitance			395		pF
C _{rss}	Reverse Transfer Capacitance			180		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V , Force Current			86.7	Α
V _{SD}	Diode Forward Voltage	V_{GS} =0V , I_{S} =15A , T_{J} =25 $^{\circ}$ C			1.2	V

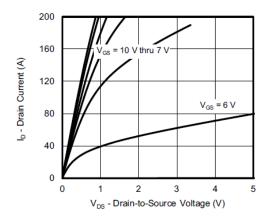
A: The value of R $_{\theta}$ JA is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA=25 $^{\circ}$ C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

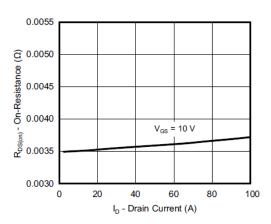
C: The current rating is based on the t≤ 10s junction to ambient thermal resistance rating.



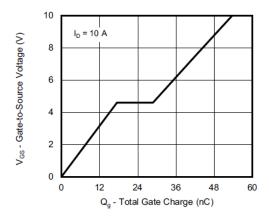
Typical Operating Characteristics



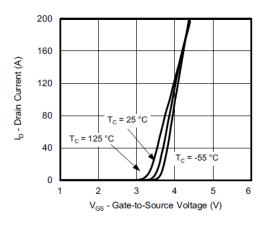
Output Characteristics



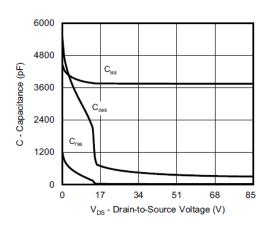
On-Resistance vs. Drain Current and Gate Voltage



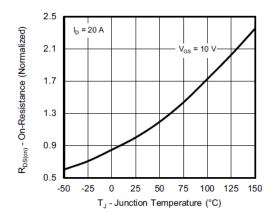
Gate Charge



Transfer Characteristics



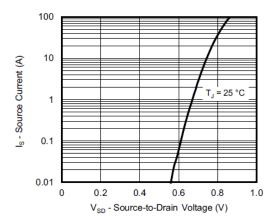
Capacitance



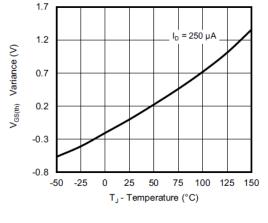
On-Resistance vs. Junction Temperature



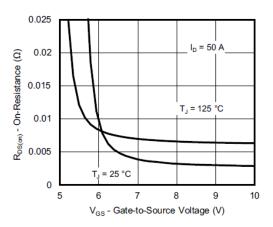
Typical Operating Characteristics



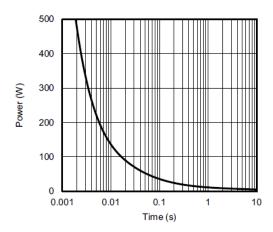
Source-Drain Diode Forward Voltage



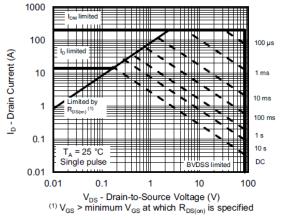
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



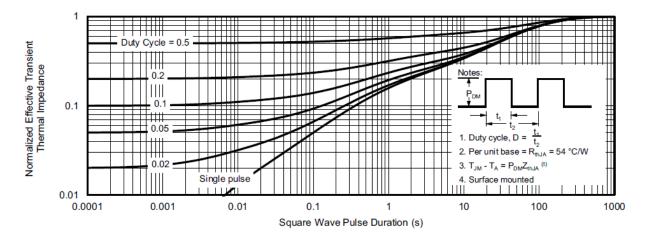
Single Pulse Power, Junction-to-Ambient



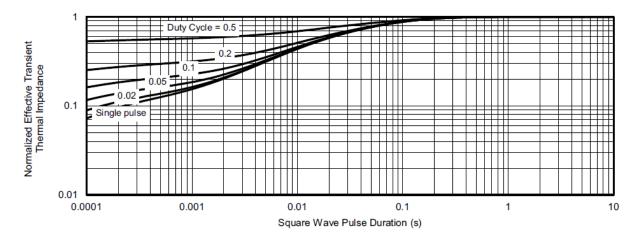
Safe Operating Area, Junction-to-Ambient



Typical Operating Characteristics



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case



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